

SKiIP 28ANB18V3



MiniSKiIP® 2

3-phase bridge rectifier +
brake chopper

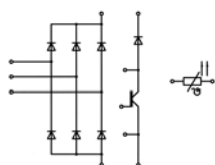
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Features

- Trench IGBTs
- Robust and soft freewheeling diodes in CAL technology
- Highly reliable spring contacts for electrical connections
- UL recognised: File no. E63532

Remarks

- Max. case temperature limited to $T_C=125^{\circ}\text{C}$
- Product reliability results valid for $T_j \leq 150^{\circ}\text{C}$ (recommended $T_{j,op} = -40 \dots +150^{\circ}\text{C}$)
- IGBT 1: brake chopper IGBT
- Diode 1: brake chopper diode
- Diode 4: rectifier diode
- The distance between terminals of temperature sensor and -rect is not sufficient for basic insulation



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Absolute Maximum Ratings				
Symbol	Conditions	Values	Unit	
IGBT 1				
V_{CES}	$T_j = 25^{\circ}\text{C}$	1700	V	
I_C	$T_j = 150^{\circ}\text{C}$	$T_s = 25^{\circ}\text{C}$	115	A
		$T_s = 70^{\circ}\text{C}$	88	A
I_C	$T_j = 175^{\circ}\text{C}$	$T_s = 25^{\circ}\text{C}$	128	A
		$T_s = 70^{\circ}\text{C}$	104	A
I_{Cnom}		100	A	
I_{CRM}	$I_{CRM} = 2 \times I_{Cnom}$	200	A	
V_{GES}		-20 ... 20	V	
t_{psc}	$V_{CC} = 1200\text{ V}$ $V_{GE} \leq 20\text{ V}$ $V_{CES} \leq 1700\text{ V}$	$T_j = 150^{\circ}\text{C}$	10	μs
T_j		-40 ... 175	$^{\circ}\text{C}$	

Absolute Maximum Ratings				
Symbol	Conditions	Values	Unit	
Diode 1				
V_{RRM}	$T_j = 25^{\circ}\text{C}$	1700	V	
I_F	$T_j = 150^{\circ}\text{C}$	$T_s = 25^{\circ}\text{C}$	105	A
		$T_s = 70^{\circ}\text{C}$	76	A
I_F	$T_j = 175^{\circ}\text{C}$	$T_s = 25^{\circ}\text{C}$	119	A
		$T_s = 70^{\circ}\text{C}$	93	A
I_{Fnom}		150	A	
I_{FRM}	$I_{FRM} = 2 \times I_{Fnom}$	300	A	
I_{FSM}	10 ms, sin 180°, $T_j = 150^{\circ}\text{C}$	860	A	
T_j		-40 ... 175	$^{\circ}\text{C}$	

Absolute Maximum Ratings				
Symbol	Conditions	Values	Unit	
Diode 4				
V_{RRM}		1800	V	
I_F	$T_j = 150^{\circ}\text{C}$	$T_s = 25^{\circ}\text{C}$	139	A
		$T_s = 70^{\circ}\text{C}$	98	A
I_{Fnom}	DC current	88	A	
I_{FSM}	10 ms, sin 180°, $T_j = 150^{\circ}\text{C}$	890	A	
I^2t	10 ms, sin. 180°, $T_j = 150^{\circ}\text{C}$	3900	A^2s	
T_j		-40 ... 150	$^{\circ}\text{C}$	

Absolute Maximum Ratings			
Symbol	Conditions	Values	Unit
Module			
$I_{t(RMS)}$	$T_{terminal} = 80^{\circ}\text{C}$, 20 A per spring	80	A
T_{stg}		-40 ... 125	$^{\circ}\text{C}$
V_{isol}	AC sinus 50 Hz, $t = 1\text{ min}$	2500	V

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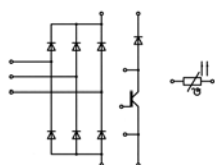
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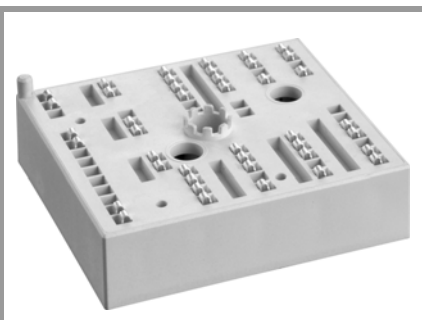
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Characteristics						
Symbol	Conditions		min.	typ.	max.	Unit
IGBT 1						
$V_{CE(sat)}$	$I_C = 100\text{ A}$ $V_{GE} = 15\text{ V}$ chiplevel	$T_j = 25^\circ\text{C}$		2.00	2.40	V
		$T_j = 150^\circ\text{C}$		2.45	2.90	V
V_{CE0}	chiplevel	$T_j = 25^\circ\text{C}$		1	1.2	V
		$T_j = 150^\circ\text{C}$		0.9	1.1	V
r_{CE}	$V_{GE} = 15\text{ V}$ chiplevel	$T_j = 25^\circ\text{C}$		10	12	m Ω
		$T_j = 150^\circ\text{C}$		16	18	m Ω
$V_{GE(th)}$	$V_{GE} = V_{CE}\text{ V}, I_C = 4\text{ mA}$		5.2	5.8	6.4	V
I_{CES}	$V_{GE} = 0\text{ V}$	$T_j = 25^\circ\text{C}$		0.1	0.3	mA
	$V_{CE} = 1700\text{ V}$					mA
C_{ies}	$V_{CE} = 25\text{ V}$ $V_{GE} = 0\text{ V}$	$f = 1\text{ MHz}$		8.82		nF
C_{oes}		$f = 1\text{ MHz}$		0.37		nF
C_{res}		$f = 1\text{ MHz}$		0.29		nF
Q_G	$-8\text{ V} \dots +15\text{ V}$			934		nC
R_{Gint}	$T_j = 25^\circ\text{C}$			4.8		Ω
$t_{d(on)}$	$V_{CC} = 900\text{ V}$	$T_j = 150^\circ\text{C}$		160		ns
t_r	$I_C = 100\text{ A}$	$T_j = 150^\circ\text{C}$		35		ns
E_{on}	$R_{G\ on} = 1\ \Omega$	$T_j = 150^\circ\text{C}$		23		mJ
$t_{d(off)}$	$R_{G\ off} = 1\ \Omega$	$T_j = 150^\circ\text{C}$		580		ns
t_f	$di/dt_{on} = 3000\text{ A}/\mu\text{s}$	$T_j = 150^\circ\text{C}$		150		ns
E_{off}	$V_{GE\ neg} = -15\text{ V}$	$T_j = 150^\circ\text{C}$		32.7		mJ
	$V_{GE\ pos} = 15\text{ V}$					
$R_{th(j-s)}$	per IGBT, $\lambda_{paste}=0.8\text{ W/K}^*\text{m}$			0.33		K/W

Characteristics						
Symbol	Conditions		min.	typ.	max.	Unit
Diode 1						
$V_F = V_{EC}$	$I_F = 100\text{ A}$ $V_{GE} = 0\text{ V}$ chiplevel	$T_j = 25^\circ\text{C}$		1.8	2.1	V
		$T_j = 150^\circ\text{C}$		1.8	2.1	V
V_{F0}	chiplevel	$T_j = 25^\circ\text{C}$		1.3	1.6	V
		$T_j = 150^\circ\text{C}$		1.1	1.2	V
r_F	chiplevel	$T_j = 25^\circ\text{C}$		4.4	5.4	m Ω
		$T_j = 150^\circ\text{C}$		6.9	8.7	m Ω
I_{RRM}	$I_F = 100\text{ A}$	$T_j = 150^\circ\text{C}$		226		A
Q_{rr}	$di/dt_{off} = 4000\text{ A}/\mu\text{s}$	$T_j = 150^\circ\text{C}$		38.5		μC
E_{rr}	$V_{GE} = -15\text{ V}$	$T_j = 150^\circ\text{C}$		26.4		mJ
$R_{th(j-s)}$	per Diode, $\lambda_{paste}=0.8\text{ W/K}^*\text{m}$			0.58		K/W

Characteristics						
Symbol	Conditions		min.	typ.	max.	Unit
Diode 4						
$V_F = V_{EC}$	$I_F = 88\text{ A}$ $V_{GE} = 0\text{ V}$ chiplevel	$T_j = 25^\circ\text{C}$		1.1	1.3	V
		$T_j = 125^\circ\text{C}$		1	1.3	V
V_{F0}	chiplevel	$T_j = 25^\circ\text{C}$	0.6	0.9	1.1	V
		$T_j = 125^\circ\text{C}$		0.7	1	V
r_F	chiplevel	$T_j = 25^\circ\text{C}$		2.3	2.6	m Ω
		$T_j = 125^\circ\text{C}$		3	3.3	m Ω
$R_{th(j-s)}$	per Diode, $\lambda_{paste}=0.8\text{ W/K}^*\text{m}$			0.64		K/W

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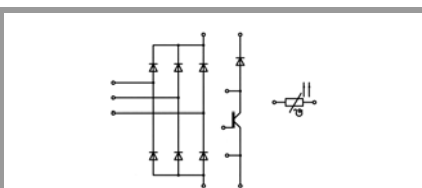
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Symbol	Conditions	min.	typ.	max.	Unit
Temperature Sensor					
R_{100}	$T_r=100^{\circ}\text{C}$ ($R_{25}=1000\Omega$)		$1670 \pm 3\%$		Ω
$R(T)$	$R(T)=1000\Omega[1+A(T-25^{\circ}\text{C})+B(T-25^{\circ}\text{C})^2]$], $A = 7.635 \cdot 10^{-3} \text{ }^{\circ}\text{C}^{-1}$, $B = 1.731 \cdot 10^{-5} \text{ }^{\circ}\text{C}^{-2}$				

Characteristics					
Symbol	Conditions	min.	typ.	max.	Unit
Module					
M_s	to heat sink	2		2.5	Nm
w	weight		55		g



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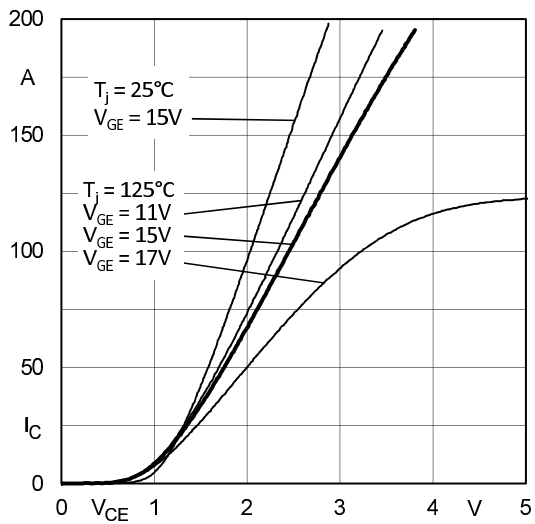


Fig. 1: Typ. output characteristic, inclusive R_{CC+EE}

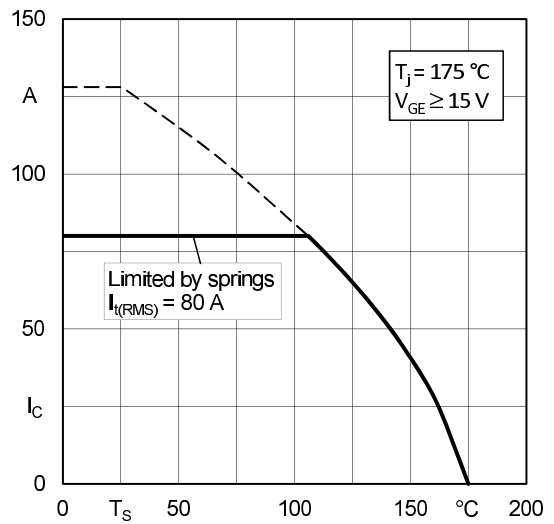


Fig. 2: Typ. rated current vs. temperature $I_C = f(T_s)$

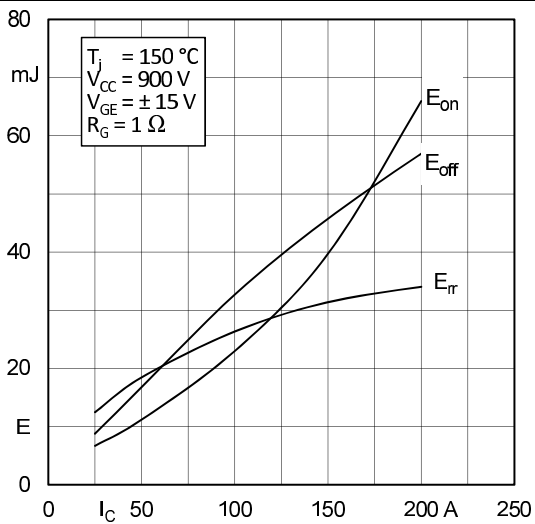


Fig. 3: Typ. turn-on /-off energy = $f(I_C)$

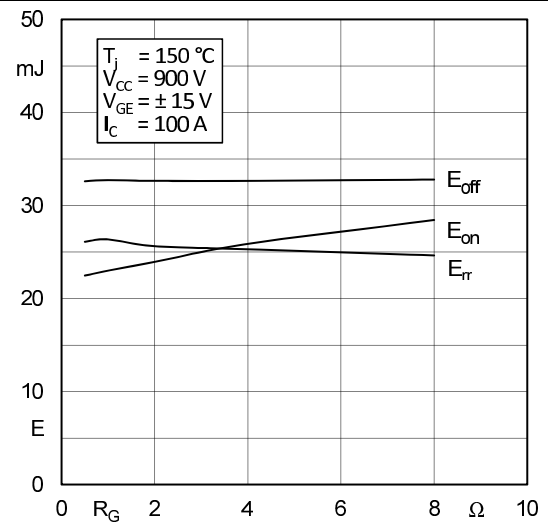


Fig. 4: Typ. turn-on /-off energy = $f(R_G)$

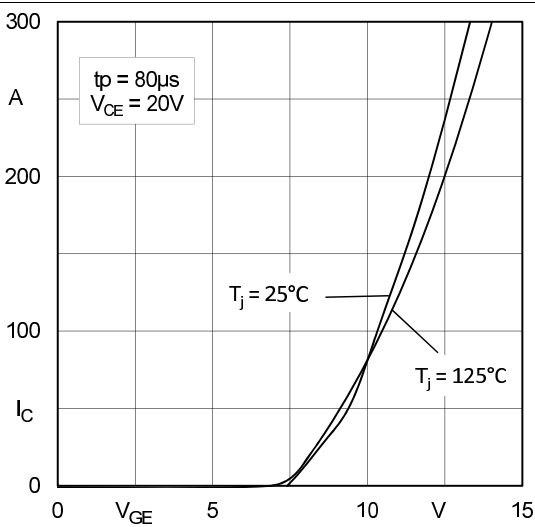


Fig. 5: Typ. transfer characteristic

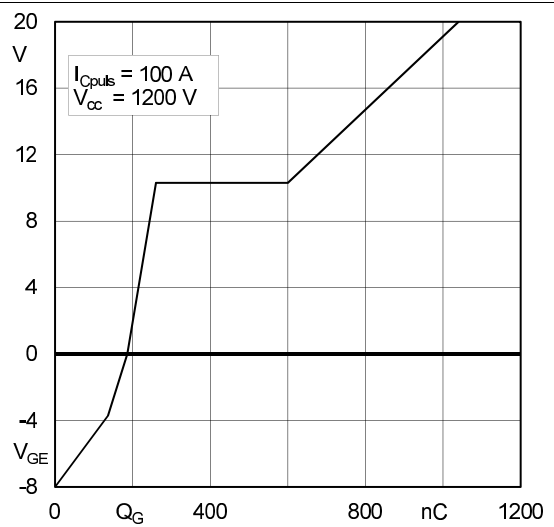


Fig. 6: Typ. gate charge characteristic

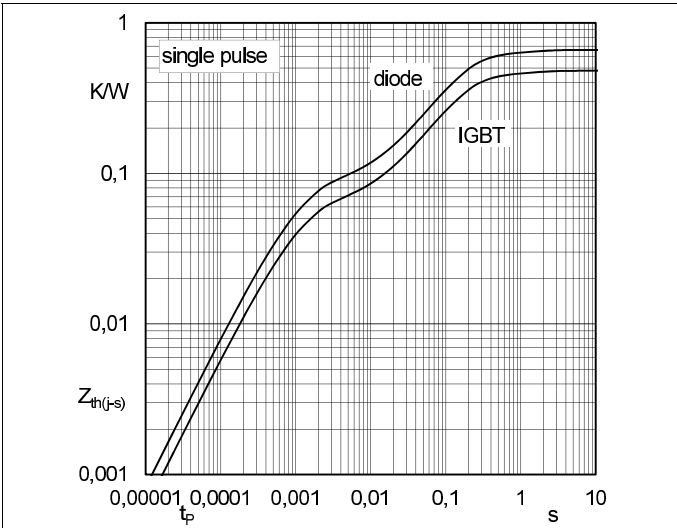


Fig. 7: Transient thermal impedance of IGBT and Diode

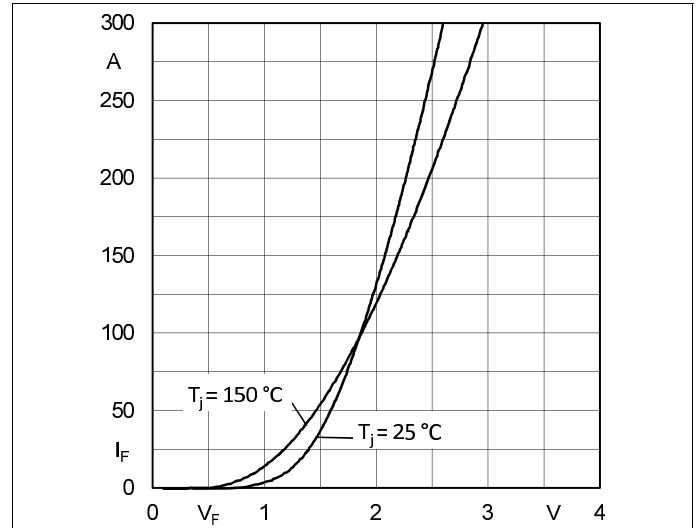


Fig. 8: CAL diode forward characteristic

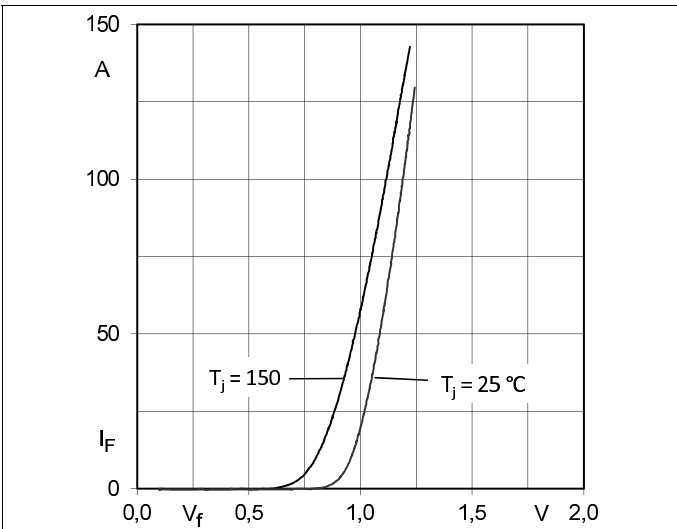
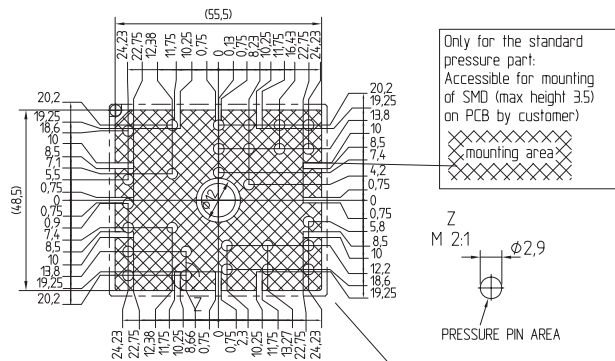
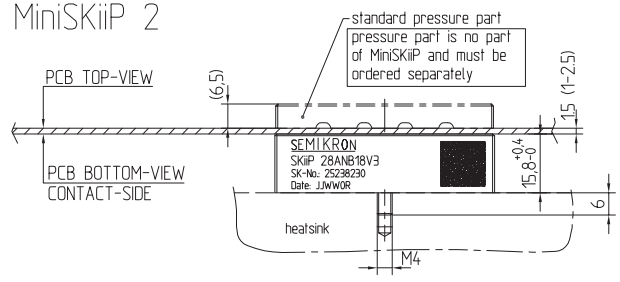


Fig. 9: Typ. input bridge forward characteristic

PCB PCB TOP-VIEW

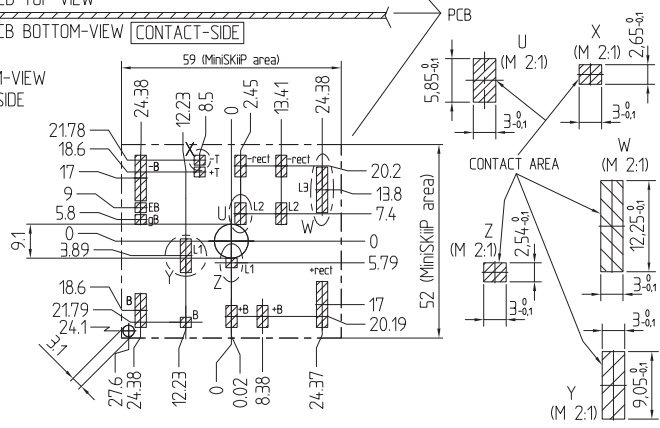


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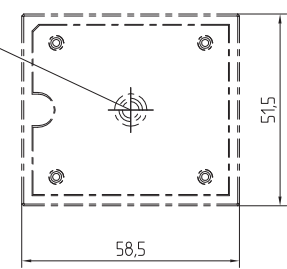


PCB TOP-VIEW PCB BOTTOM-VIEW CONTACT-SIDE

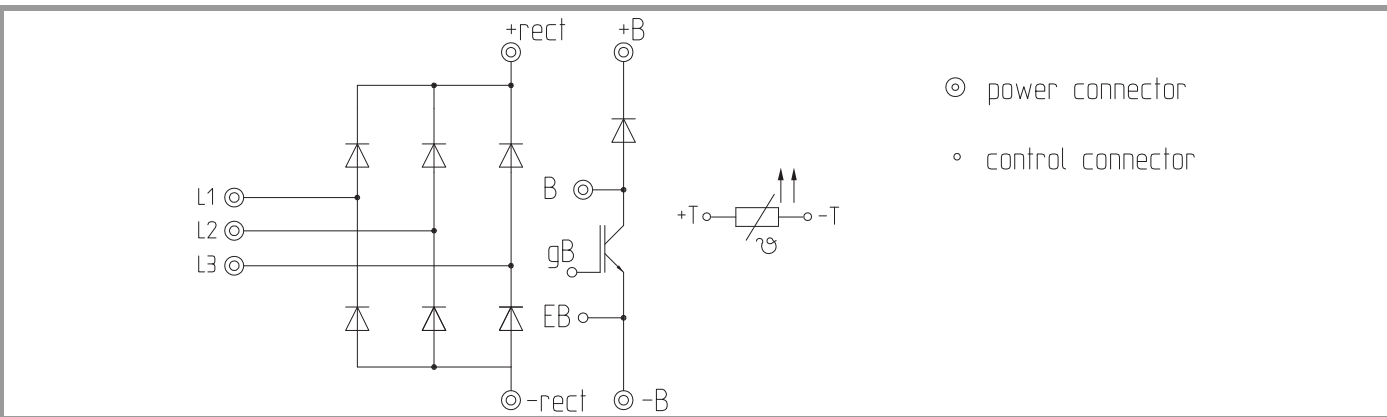
PCB BOTTOM-VIEW CONTACT-SIDE



For mounting please follow the assembly instruction



pinout, dimensions



pinout

This is an electrostatic discharge sensitive device (ESDS), international standard IEC 60747-1, Chapter IX

* The specifications of our components may not be considered as an assurance of component characteristics. Components have to be tested for the respective application. Adjustments may be necessary. The use of SEMIKRON products in life support appliances and systems is subject to prior specification and written approval by SEMIKRON. We therefore strongly recommend prior consultation of our staff.